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July 2017

FDG8850NZ

Dual N-Channel PowerTrench[®] MOSFET 30V,0.75A,0.4 Ω

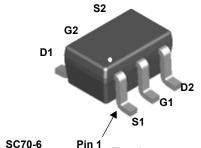
Features

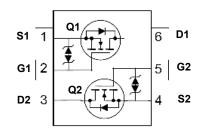
- Max $r_{DS(on)} = 0.4\Omega$ at $V_{GS} = 4.5V$, $I_D = 0.75A$
- Max $r_{DS(on)}$ = 0.5 Ω at V_{GS} = 2.7V, I_D = 0.67A
- Very low level gate drive requirements allowing operation in 3V circuits(V_{GS(th)} <1.5V)
- Very small package outline SC70-6
- RoHS Compliant



General Description

This dual N-Channel logic level enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. This device has been designed especially for low voltage applications as a replacement for bipolar digital transistors and small signal MOSFETs. Since bias resistors are not required, this dual digital FET can replace several different digital transistors, with different bias resistor values.





The pinouts are symmetrical; pin 1 and pin 4 are interchangeable. Units inside the carrier tape can be of either orientation (0 deg and 180 deg) and will not affect the functionality of the device.

MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V_{DS}	Drain to Source Voltage		30	V
V_{GS}	Gate to Source Voltage		±12	V
	Drain Current -Continuous		0.75	
ID	-Pulsed		2.2	A
Б	Power Dissipation for Single Operation	(Note 1a)	0.36	10/
P_{D}		(Note 1b)	0.30	W
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JA}$	Thermal Resistance, Junction to Ambient Single operation	(Note 1a)	350	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient Single operation	(Note 1b)	415	C/VV

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
.50	FDG8850NZ	7"	8mm	3000 units

Electrical Characteristics $T_J = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units			
Off Characteristics									
BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0V$	30			V			
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I _D = 250μA, referenced to 25°C		25		mV/°C			
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24V, V _{GS} = 0V			1	μΑ			
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 12V$, $V_{DS} = 0V$			±10	μΑ			

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	0.65	1.0	1.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I _D = 250μA, referenced to 25°C		-3.0		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 4.5V, I_D = 0.75A$ $V_{GS} = 2.7V, I_D = 0.67A$ $V_{GS} = 4.5V, I_D = 0.75A, T_J = 125^{\circ}C$		0.25 0.29 0.36	0.4 0.5 0.6	Ω
g _{FS}	Forward Transconductance	$V_{DS} = 5V, I_{D} = 0.75A$		3		S

Dynamic Characteristics

C _{iss}	Input Capacitance		90	120	pF
C _{oss}	Output Capacitance	V_{DS} = 10V, V_{GS} = 0V, f= 1MHZ	20	30	pF
C _{rss}	Reverse Transfer Capacitance		15	25	pF

Switching Characteristics (note 2)

t _{d(on)}	Turn-On Delay Time		4	10	ns
t _r	Rise Time	$V_{DD} = 5V, I_{D} = 0.5A,$	1	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 4.5V, R_{GEN} = 6\Omega$	9	18	ns
t _f	Fall Time		1	10	ns
Q_g	Total Gate Charge		1.03	1.44	nC
Q_{gs}	Gate to Source Charge	V_{GS} =4.5V, V_{DD} = 5V, I_{D} = 0.75A	0.29		nC
Q _{gd}	Gate to Drain "Miller" Charge		0.17		nC

Drain-Source Diode Characteristics and Maximum Ratings

I _S	Maximum Continuous Drain-Source Diode Forward Current				0.3	Α
V_{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 0.3A$	(Note 2)	0.76	1.2	V

Notes:

^{1.} R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BJC} is guaranteed by design while R_{BJA} is determined by the user's board design.



a. 350° C/W when mounted on a 1 in² pad of 2 oz copper .



b. 415°C/W when mounted on a minimum pad of 2 oz copper.

Scale 1:1 on letter size paper.

2. Pulse Test: Pulse Width < $300\mu s,$ Duty cycle < 2.0%.

Typical Characteristics T_J = 25°C unless otherwise noted

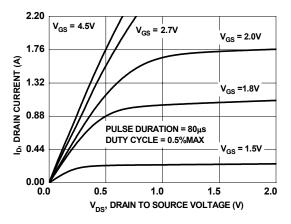


Figure 1. On-Region Characteristics

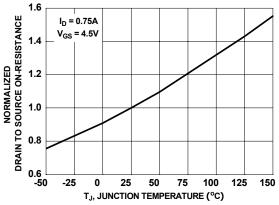


Figure 3. Normalized On - Resistance vs Junction Temperature

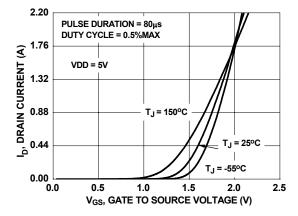


Figure 5. Transfer Characteristics

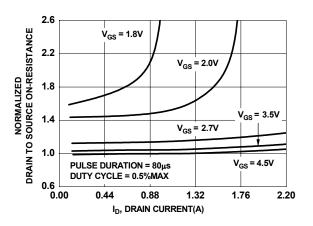


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

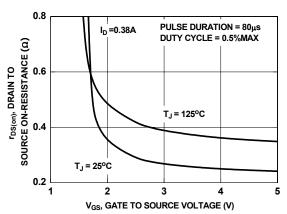


Figure 4. On-Resistance vs Gate to Source Voltage

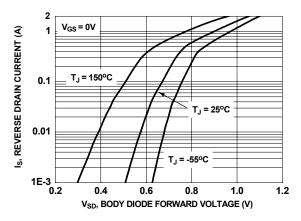


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics T_J = 25°C unless otherwise noted

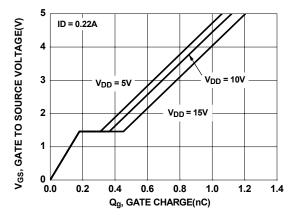


Figure 7. Gate Charge Characteristics

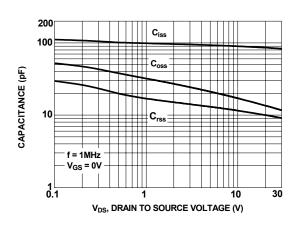
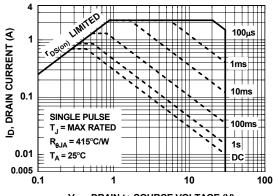


Figure 8. Capacitance vs Drain to Source Voltage



V_{DS}, DRAIN to SOURCE VOLTAGE (V) Figure 9. Forward Bias Safe Operating Area

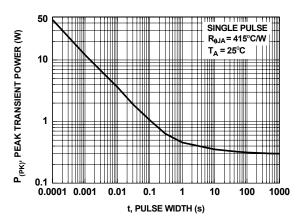


Figure 10. Single Pulse Maximum Power Dissipation

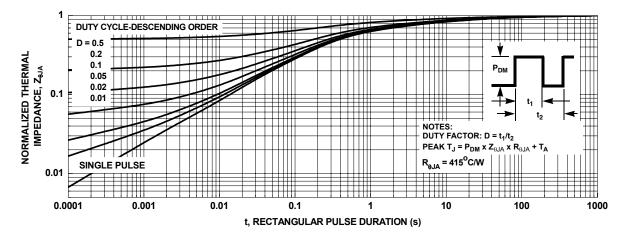
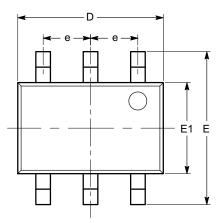
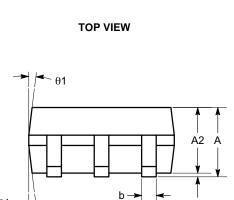


Figure 11. Transient Thermal Response Curve

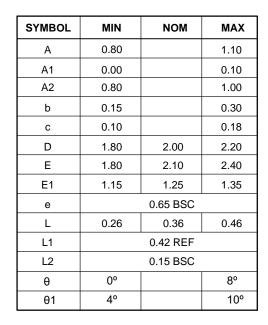
SC-88 (SC-70 6 Lead), 1.25x2 CASE 419AD-01

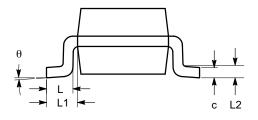
ISSUE A





SIDE VIEW





END VIEW

Notes:

(1) All dimensions are in millimeters. Angles in degrees.

A1

(2) Complies with JEDEC MO-203.

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